

Application Data Sheet
APPLICATION INFORMATION

Application Number::
Filing Date::
Application Type:: Regular
Subject Matter:: Utility
Suggested classification::
Suggested Group Art Unit::
CD-ROM or CD-R?:: None
Number of CD Disks:
Number of Copies of CDs::
Sequence Submission?::
Computer Readable From (CRF)?:: No
Number of Copies of CRF::
Title:: CLEANING COMPOSITION FOR REMOVING
RESISTS AND MANUFACTURING METHOD OF
SEMICONDUCTOR DEVICE
Attorney Docket Number:: 402696
Request for Early Publication?:: No
Request for Non-Publication?:: No
Suggested Drawing Figure::
Total Drawing Sheets:: 6
Small Entity?:: No
Latin Name::
Variety denomination name::
Petition Included?:: No
Petition Type::
Licensed US Govt. Agency::
Contract or Grant Numbers::
Secrecy Order in Parent Appl.?:: No

APPLICANT INFORMATION

Applicant Authority Type:: Inventor
Primary Citizenship Country:: Japan
Status:: Full Capacity
Given Name:: Itaru
Middle Name::
Family Name:: KANNO
Name Suffix::
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Inventor Authority Type:: Inventor
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Applicant Authority Type:: Inventor
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State or Province of mailing address::	Kyoto
Country of mailing address::	Japan
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Status::	Full Capacity
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Middle Name::	
Family Name::	AOYAMA
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Country of Residence::	Japan
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State or Province of mailing address::	Kanagawa
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Inventor Authority Type:: Inventor
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CORRESPONDENCE INFORMATION

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REPRESENTATIVE INFORMATION

Representative Customer Number:: 23548

Representative Designation:: Registration Number:: Representative Name::

DOMESTIC PRIORITY INFORMATION

Application:: Continuity Type:: Parent Application:: Parent Filing Date::

FOREIGN APPLICATION INFORMATION

Country::	Application Number::	Filing Date::	Priority Claimed
Japan	2002-203987	07/12/02	Yes
Japan	2003-174816	06/19/03	No

ASSIGNEE INFORMATION

Assignee name:: Renesas Technology Corp.

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State or Province of
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Country of mailing
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Assignee name:: Matsushita Electric Industrial Co., Ltd.

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City of mailing address:: Kadoma-shi

State or Province of
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Country of mailing
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